HARTING DIN Signal har-bus 64S female connector RoHS . SI

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Recommended configuration of plated through holes for press-in termination

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In addition to the hot-air-level (HAL), other PCB surfaces are getting more important. Due to their different properties – such as mechanical strength a coefficient of friction - we recommend the following configuration of PCB through holes.

General information

			÷	:			-	
-	Design	according to IEC 61076-4	-113	type: har-bus64S female	with switching elements		_	
	No. of contacts	max. 160						
	Contact spacing	2,54mm						
	Test voltage	1000V						
	Contact resistance	max. 20m0hm for rows a, b, c / max. 30m0hm for rows d, z / max. 60m0hm for switching elements						
в	Insulation resistance	min. 10 ¹² Ohm					_	
	Working current	1A at 70°C (see derating	diagram)					
	Temperature range	-40°C +105°C (due to	limitations of PCB materia	ι)			-	
	Termination technology	press-in					-	
			minimum distance	rows a, b, c	rows d, z		-	
_			clearance	1,2mm	1,2mm	0,5mm	-	
	Clearance & creepage	between 2 rows	сгеераде	1,2mm	1,2mm	0,7mm	Asse	
		between 2	clearance	1,2mm	1,0mm	0,5mm		
		contacts in a row	сгеераде	1,2mm	1,0mm	0,7mm	- It is infor	
	Insertion and withdrawal force	max. 180N			· ·	· ·	- """"	
c	PCB thickness	min. 1,6mm					-	
	Mating cycles	PL 2 acc. to IEC 61076-4	-113	250 mating cycles			– Addi	
	UL file	E102079		,, _,, _			- The	
	RoHS - compliant	Yes					— posit	
	Leadfree	Yes	·	·			- ^{3wii}	
							-	
	Insulator material	:	.	:			-	
							-	
	Material	LCP (Liquid Cristal Polym	ег)				-	
	Colour	nature (black for cover on switching elements)						
5	UL classification	UL 94-V0						
	Material group acc. to IEC 60664-1	IIIa (175 <u><</u> CTI < 400)					-	
							-	
	Contact material						-	
		· · · · · · · · · · · · · · · · · · ·					-	
	Contact material	Copper alloy					-	
	Plating termination zone	Ni					-	
	Plating contact zone	Au over Ni					-	
							-	
	Derating diagram acc. to IEC 60512-5 (Curre	nt carrying capacity)	.	.			-	
	סביסיוווק טומקימוו מכנ. זט ובב טטטוב-ט נבטו בחו במדו אווק במאמנוואו 							
-	The current carrying capacity is limited by maximum temperature							
	f materials for inserts and contacts including terminals.							
	The surgest area that is 111.0							
	The current capacity curve is valid for cont interrupted current loaded contacts of conn	tinuous, non $\Xi_{1,5}$						
	simultaneous power on all contacts is given,		peo					
	the maximum temperature.	-						
		Intrent capacity curve is valid for continuous, non ipted current loaded contacts of connectors when aneous power on all contacts is given, without exceeding aximum temperature. I and test procedures according to DIN IEC 60512-5 elective loading higher currents can be transmitted. The						
	With coloctive loading higher average	a tappemitted The	lect		$ $ \wedge			
	With selective loading higher currents can b requirements according to VITA 17 are fulfi	ш _{0,5}		+		HART		
_	requirements according to VITA 1.7 are fulfilled.							
F			0,0			\rightarrow	HARTI	
			0 20	40 60	80 100	120 140		
					Temperature [°C]	0,5mm 0,7mm 0,5mm 0,7mm	D-323	
	1	2	2		1			

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structions

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recommended to use HARTING press-in tools to ensure a reliable about the press-in process.

nformation

har-bus®64 connector with switches allows an automatic switchir 21-22, b4-5, b6-7, b8-9 and b10-11.

ements open automatically when the daughter card is mated, so

	•	ensions in mm l Size DIN A3	Scale 1:1	Free	ee size tol.		
	ll rights.	s reserved	Created by STORCK		I	Inspected by ELLERMANN	
Depa	^{rtment} EC	Title	Cian.	nal har-bus 64			
HARTING Electro	lectronics GmbH		יאווט				Sigila
D-32339 Espelkamp			Type DS Number 020			2032	
5			6				

	7		8	
÷				
-	:		<u>.</u>	
			1	
and	Tin plated PCB (HAL)	Drilled hole Ø	1,15±0,025 mm	
	acc. to EN 60352-5	Sn	max. 15 µm	
		plated hole Ø	0,94 - 1,09 mm	
	Chemical tin plated	Drilled hole Ø	1,15±0,025 mm	
	PCB	Sn	min. 0,8µm	
		plated hole Ø	1,00 - 1,10 mm	
		Drilled hole Ø	1,15±0,025 mm	
	Gold /Nickel plated PCB	Ni Au	3 - 7 μm 0,05 - 0,12 μm	
		plated hole Ø	1,00 - 1,10 mm	
		Drilled hole Ø	1,15±0,025 mm	
	Silver plated PCB		0,1 - 0,3 µm	В
		Ag plated hole Ø	1,00 - 1,10 mm	
	Conner plated	Drilled hole Ø	1,15±0,025 mm	
	Copper plated PCB (OSP)	plated hole Ø	1,00 - 1,10 mm	
	1 20 (0317	platen note p	1,00 - 1,10 11111	
Dress	s-in process. Please ref	er to the catalogue for i	tools, machines and further	
P	F			
_				C
-				
n In t	the case of an unmated	daughter card the come	ctor bridges the signals at	
'y			cror bridges the signats at	
that t	he daughter card accep	ts the ongoing signal dais	sy-chain.	
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		Sub. DS 02032100101 / ECC		E
	Standardisation	Sub. DS 02032100101 / ECO Date	State	E
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	HOFFMANN	Sub. DS 02032100101 / ECO Date 2017-12-08	State Final Release Doc-Key / ECM-Nr.	-
		Sub. DS 02032100101 / ECO Date 2017-12-08	State Final Release Doc-Key / ECM-Nr. 100557034/UGD/001/B 500000128957	E
	HOFFMANN female connector	Sub. DS 02032100101 / ECO Date 2017-12-08	State Final Release Doc-Key / ECM-Nr. 100557034/UGD/001/B 500000128957	-
54S	HOFFMANN	Sub. DS 02032100101 / ECO Date 2017-12-08	State Final Release Doc-Key / ECM-Nr. 100557034/UGD/001/B 500000128957 Rev. p Page	-
45	HOFFMANN female connector	Sub. DS 02032100101 / ECO Date 2017-12-08	State Final Release Doc-Key / ECM-Nr. 100557034/UGD/001/B 500000128957	

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